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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TSAN-CHUN WANG	09/26/2014
CHUN HSIUNG TSAI	09/26/2014
ZIWEI FANG	09/26/2014

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
Street Address:	NO. 8, LI-HSIN RD. 6
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK
City:	HSIN-CHU
State/Country:	TAIWAN
Postal Code:	300-77

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15865012

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	20140898/24061.2969US03
NAME OF SUBMITTER:	JANIE MARTINEZ-HOLM
SIGNATURE: /Janie Martinez-Holm/	
DATE SIGNED:	01/10/2018

Total Attachments: 2

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PATENT REEL: 044582 FRAME: 0962 504722234

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Docket No.: 2014-0898 / 24061.2969

Customer No.: 42717

ASSIGNMENT

WHEREAS, we, (1) Tsan-Chun Wang of No.18, Lane 110, Gaofeng Road East District Hsinchu City 300, Taiwan R.O.C. (2) Chun Hsiung Tsai of No.7, Daxiang Road, Xinpu Township, Hsinchu County 305, Taiwan R.O.C. (3) Ziwei Fang of 9 Songcui Road 17th Lane Baoshan Township, Hsinchu, Taiwan R.O.C.

have invented certain improvements in

ION IMPLANTATION METHODS AND STRUCTURES THEREOF

tor which v	we have executed an application for Letters Patent of th	e United States of Ame	rica,	
•	of even date filed herewith; and filed on and assigned application no	umber	; and	
	S, we authorize the attorney of record to update the n as deemed necessary (i.e., filing date, serial number, e		de Patent	Office

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd., ("TSMC"), No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu, Taiwan 300-77, Republic of China. is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

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AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Inventor Name:

Tsan-Chun Wang

Residence Address:

No.18, Lane 110, Gaofeng Road

East District Hsinchu City 300, Taiwan R.O.C.

Dated: __>0/4. &

Inventor Name:

Chun Hsiung Tsai

Residence Address:

No.7, Daxiang Road,

Xinpu Township, Hsinchu County

305, Taiwan R.O.C.

Inventor Name:

Ziwei Fang

Residence Address:

9 Songcui Road 17th Lane

Baoshan Township, Hsinchu, Taiwan R.O.C.

Dated: 2014/9/26

R-24061.2969 Assignment

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